(Following Paper ID and Roll No. to be filled in your Answer Book)				
PAPER ID: 0389	Roll No.			

B. Tech.

(SEM. VIII) THEORY EXAMINATION 2010-11 RELIABILITY AND QUALITY MANAGEMENT

Time: 3 Hours Total Marks: 100

Note: (1) Attempt all questions.

- (2) Marks allotted to each question are indicated on right hand side.
- 1. Attempt any four parts of the following: $(4\times5=20)$
 - (a) Define Quality. Explain the difference between quality and total quality control.
 - (b) Explain the difference between Early failure and Wear out failures giving suitable examples.
 - (c) Explain how Availability, Complexity of devices, maintainability, maintenance system practiced and failure history are responsible for system effectiveness?
 - (d) Explain the Bath Tub Curve.
 - (e) How are Quality and Reliability related? Up to what extent cost incurred on quality improvement is justified in reference to Reliability?
 - (f) Explain Preventive maintenance. Up to what extent expenses incurred on preventive maintenance are justified.

- 2. Attempt any two parts of the following: $(2\times10=20)$
 - (a) What do you understand by Probability Distribution? Explain Poisson Distribution. Under what condition this distribution is applicable?
 - (b) Explain the importance of Weibull Distribution. Where it can be applied? Give suitable examples.
 - (c) An Electronic assembly consists of two subsystems, A and B. Each assembly is given one checkout test. Records on 100 preliminary checkout tests show that subsystem A failed 10 times. Subsystem B alone failed 15 times. Both systems A and B failed together five times. Find, what is the probability of A failing, given that B has failed.
- 3. Attempt any two parts of the following: $(2\times10=20)$
 - (a) Explain various methods of Data collection and storage. How component reliability can be established using such data.
 - (b) Explain the Fault Free technique for prediction of system reliability giving its applications.
 - (c) Discuss various models for improving System Reliability improvement in detail.
- 4. Attempt any two parts of the following: $(2\times10=20)$
 - (a) Briefly describe two failure modes that can occur in modern Integrated circuits. How are Temperature, Electrial stresses and manufacturing quality responsible for these failures?

- (b) Explain the effect of the following on proper functioning of Electronic components:
 - (i) Distortion and Jitter.
 - (ii) Electromagnetic Interfaces.
- (c) Discuss the reliability of electronic components as an overall contributor to system reliability specially from the designers point of view.
- 5. Attempt any two parts of the following: (2×10=20)
 - (a) What do you understand by total quality management?

 Discuss its key elements in detail.
 - (b) What is ISO? What are the advantages of ISO certification? Discuss in detail.
 - (c) Write notes on any two:
 - (i) Quality Circles
 - (ii) SWOT Analysis
 - (iii) Quality Audit
 - (iv) Cost of Quality.